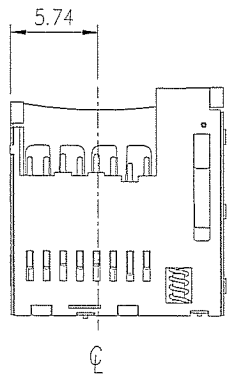
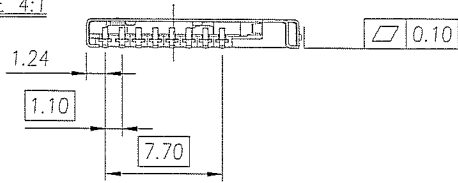


P.C.B Layout (Top View)

REV	MODIFICATION	DATE	DRAW
B	EN-13-0506	2013/05/07	Stacy

- NOTES:
- Material:
 Housing: Thermoplastic UL94V-0
 Color: Black (Comply to SONY SS-00259)
 Push Bar: Thermoplastic UL94V-0
 Color: Black (Comply to SONY SS-00259)
 Contact: Phosphor Bronze.
 Tin 100u" at Solder Tail, See "Ordering Information" for Contact Area Plating (Comply to SONY SS-00259)
 Shell: SUS 304.t=0.15mm.(Comply to SONY SS-00259)
 - Within the 0.3mm high above the shell, it's the function area and please don't do any design for mechanism.
 - This product applies to the mechanical specification version 1.0 of SanDisk TransFlash Memory Module.
 - Operating Temperature : -40°C TO +85°C
 Storage Temperature Range : -40°C TO +85°C

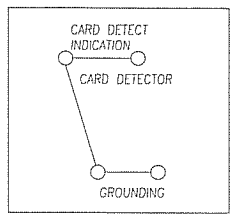


Ordering Information:
TFCMF-208XXBOTX-UTE-A

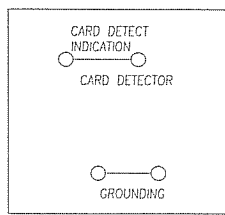
Contact Area Plating:
 01-- Gold Flash Plating
 05-- 5u" Gold Plating
 10-- 10u" Gold Plating
 15-- 15u" Gold Plating

PACKAGE TYPE :
 0 : TRAY
 1 : TAPE REEL

PLATING TYPE :
 T: Comply to SONY SS-00259



WITHOUT CARD



CARD INSERTED



T-FLASH		DIMENSION IN mm [Inch]		PROD. SPEC.
PIN	NAME	TOLERANCE UNLESS OTHERWISE SPECIFIED		SP0098
1	DAT2			PKG. SPEC. PPP-TFC-001
2	CD/DAT3			
3	CMD	.X±0.10	.X"±	APPROVE Gary
4	VDD			CHECK Gary
5	CLK	.XX±0.05	.X"±	
6	VSS2			DRAW Gary
7	DAT0	.XXX±	.XX"±	
8	DAT1			

KINGFONT PRECISION INDUSTRIAL CO., LTD.	
TITLE	T-FLASH CARD CONNECTOR PUSH PUSH (NORMAL CLOSE) CUSTOMER DRAWING
FILE NO. KFP-098	DWG NO. TFCMF-208XXBOTX-UTE-A
SIZE A4	PROJ. SHEET 1 / 1 SCALE 2:1 REV B